

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Danielle A. Thomas, et al.

Serial No.:

10/091,743

Filed:

March 6, 2002

For:

SYSTEM AND METHOD FOR PROVIDING A REDISTRIBUTION METAL LAYER IN AN

INTEGRATED CIRCUIT

Group No.:

3729

Examiner:

Donghai D. Nguyen

MAIL STOP AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sirs:

AMENDMENT AND RESPONSE UNDER 37 C.F.R. §1.116

In response to the Office Action dated October 29, 2004, please amend the aboveidentified patent application as follows.